



DMT32M5LPS

30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	ID Tc = +25°C
001/	2.0mΩ @ V _{GS} = 10V	150A
30V	3.0mΩ @ V _{GS} = 4.5V	100A

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- DC-DC converters
- Load switches

Features

- Thermally Efficient Package-Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)



3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information (Note 4)

Part Number	Baakaga	Packing		
Part Number	Package	Qty.	Carrier	
DMT32M5LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMT32M5LPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			Vdss	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) State State Tc = +25°C Tc = +70°C			ID	150 120	А
Maximum Continuous Body Diode Forward Current (Note 6)			ls	80	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	350	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	350	А
Avalanche Current, L = 0.1mH			las	50	A
Avalanche Energy, L = 0.1mH			E _{AS}	140	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.2	W
Thermal Resistance, Junction to Ambient (Note 5)		RθJA	54	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	PD	100	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	30		—	V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	IDSS			1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	lgss		_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 1mA$	
Statia Drain Source On Registeres			1.6	2.0		VGS = 10V, ID = 30A	
Static Drain-Source On-Resistance	RDS(ON)		2.3	3.0	11122	$V_{GS} = 4.5V, I_D = 30A$	
Diode Forward Voltage	Vsd		0.8	1.1	V	$V_{GS} = 0V, I_{S} = 30A$	
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		3944		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		1267				
Reverse Transfer Capacitance	Crss		186	—			
Gate Resistance	Rg		0.6		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge ($V_{GS} = 4.5V$)	Qg		34	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	68	_	~ C	V _{DS} = 15V, I _D = 20A	
Gate-Source Charge	Qgs		8	_	no		
Gate-Drain Charge	Qgd	_	15	_			
Turn-On Delay Time	tD(ON)	_	7.2	_			
Turn-On Rise Time	t _R	_	13.2	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$ $I_D = 15A, R_G = 3\Omega$	
Turn-Off Delay Time	tD(OFF)		37.5	_			
Turn-Off Fall Time	t⊢	_	23.9	_			
Body Diode Reverse Recovery Time	t _{RR}		28.7	_	ns		
Body Diode Reverse Recovery Charge	QRR	—	45.8	_	nC	$1S = 15A$, $ui/ul = 500A/\mu S$	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.



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DMT32M5LPS Document number: DS39663 Rev. 5 - 2







Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:



PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	1,	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC			
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

PowerDI5060-8



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
Х	0.610	
X1	4.100	
X2	0.755	
X3	4.420	
X4	5.610	
Y	1.270	
Y1	0.600	
Y2	1.020	
Y3	0.295	
Y4	1.825	
Y5	3.810	
Y6	0.180	
Y7	6.610	

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	5.190
X3	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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